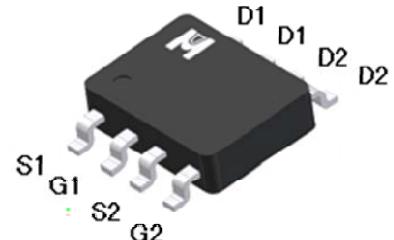
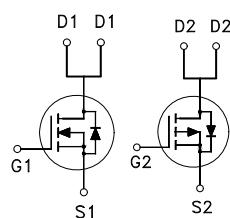


N & P-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

	N-CH	P-CH
BV _{DSS}	30V	-30V
R _{DSON} (MAX.)	21mΩ	35mΩ
I _D	7.5A	-6A



UIS, Rg 100% Tested

Pb-Free Lead Plating & Halogen Free



ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS		UNIT
Gate-Source Voltage		V _{GS}	N-CH	P-CH	V
			±20	±20	
Continuous Drain Current	T _A = 25 °C	I _D	7.5	-6	A
	T _A = 100 °C		5.5	-5	
Pulsed Drain Current ¹		I _{DM}	30	-24	
Avalanche Current		I _{AS}	10	-10	
Avalanche Energy L = 0.1mH, ID=7.5A, RG=25Ω(N) L = 0.1mH, ID=-6A, RG=25Ω(P)		E _{AS}	2.8	1.8	mJ
Repetitive Avalanche Energy ²		E _{AR}	1.4	0.9	
Power Dissipation	T _A = 25 °C	P _D	2		W
	T _A = 100 °C		0.8		
Operating Junction & Storage Temperature Range		T _j , T _{stg}	-55 to 150		°C

100% UIS testing in condition of V_D=15V, L=0.1mH, V_G=10V, I_L=7.5A, Rated V_{DS}=30V N-CH

100% UIS testing in condition of V_D=15V, L=0.1mH, V_G=-10V, I_L=-6A, Rated V_{DS}=-30V P-CH

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Case	R _{θJC}		25	°C / W
Junction-to-Ambient ³	R _{θJA}		62.5	

¹Pulse width limited by maximum junction temperature.

²Duty cycle ≤ 1%

³62.5°C / W when mounted on a 1 in² pad of 2 oz copper.

ELECTRICAL CHARACTERISTICS (T_A = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT	
			MIN	TYP	MAX		
STATIC							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	N-CH	30			
		V _{GS} = 0V, I _D = -250μA	P-CH	-30			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	N-CH	1	1.5	3	
		V _{DS} = V _{GS} , I _D = -250μA	P-CH	-1	-1.5	-3	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V	N-CH			±100	
		V _{DS} = 0V, V _{GS} = ±20V	P-CH			±100	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 24V, V _{GS} = 0V	N-CH			1	
		V _{DS} = -24V, V _{GS} = 0V	P-CH			-1	
		V _{DS} = 20V, V _{GS} = 0V, T _J = 125 °C	N-CH			25	
		V _{DS} = -20V, V _{GS} = 0V, T _J = 125 °C	P-CH			-25	
On-State Drain Current ¹	I _{D(ON)}	V _{DS} = 10V, V _{GS} = 10V	N-CH	7.5			
		V _{DS} = -5V, V _{GS} = -10V	P-CH	-6			
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 10V, I _D = 7.5A	N-CH		17	21	
		V _{GS} = -10V, I _D = -6A	P-CH		30	35	
		V _{GS} = 4.5V, I _D = 5.5A	N-CH		25	30	
		V _{GS} = -4.5V, I _D = -5A	P-CH		50	60	
Forward Transconductance ¹	g _{fs}	V _{DS} = 5V, I _D = 7.5A	N-CH		16		
		V _{DS} = -5V, I _D = -6A	P-CH		12		
DYNAMIC							
Input Capacitance	C _{iss}	N-CH V _{GS} = 0V, V _{DS} = 15V, f = 1MHz P=CH V _{GS} = 0V, V _{DS} = -15V, f = 1MHz	N-CH		520		
			P-CH		910		
Output Capacitance	C _{oss}		N-CH		88		
			P-CH		143		
Reverse Transfer Capacitance	C _{rss}		N-CH		62		
			P-CH		108		

Gate Resistance	R_g	$V_{GS} = 15mV, V_{DS} = 0V, f = 1MHz$	N-CH		2.0		Ω
			P-CH		4.0		
Total Gate Charge ^{1,2}	$Q_g(V_{GS}=10V)$ $Q_g(V_{GS}=-10V)$	N-CH $V_{DS} = 15V, V_{GS} = 10V,$ $I_D = 7.5A$ P-CH $V_{DS} = -15V, V_{GS} = -10V,$ $I_D = -6A$	N-CH		11.5		nC
	$Q_g(V_{GS}=4.5V)$ $Q_g(V_{GS}=-4.5V)$		P-CH		13.3		
Gate-Source Charge ^{1,2}	Q_{gs}		N-CH		5		
Gate-Drain Charge ^{1,2}	Q_{gd}		P-CH		7		
Turn-On Delay Time ^{1,2}	$t_{d(on)}$	N-CH $V_{DS} = 15V,$ $I_D = 1A, V_{GS} = 10V, R_{GS} = 6\Omega$ P-CH	N-CH		1.6		
Rise Time ^{1,2}	t_r		P-CH		2.1		
Turn-Off Delay Time ^{1,2}	$t_{d(off)}$	$V_{DS} = -15V,$ $I_D = -1A, V_{GS} = -10V, R_{GS} = 6\Omega$	N-CH		2.8		
Fall Time ^{1,2}	t_f		P-CH		3.2		

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_c = 25^\circ C$)

Continuous Current	I_S		N-CH		2.3	A
			P-CH		-2.3	
Pulsed Current ³	I_{SM}		N-CH		9.2	
			P-CH		-9.2	
Forward Voltage ¹	V_{SD}	$I_F = I_S, V_{GS} = 0V$	N-CH		1.2	V
			P-CH		-1.2	
Reverse Recovery Time	t_{rr}		N-CH		50	nS
			P-CH		55	
Peak Reverse Recovery Current	$I_{RM(REC)}$	$I_F = I_S, dI_F/dt = 100A / \mu s$	N-CH		30	A
			P-CH		-24	
Reverse Recovery Charge	Q_{rr}		N-CH		2	nC
			P-CH		2.2	

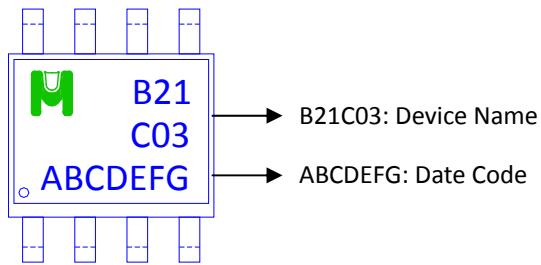
¹Pulse test : Pulse Width $\leq 300 \mu sec$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

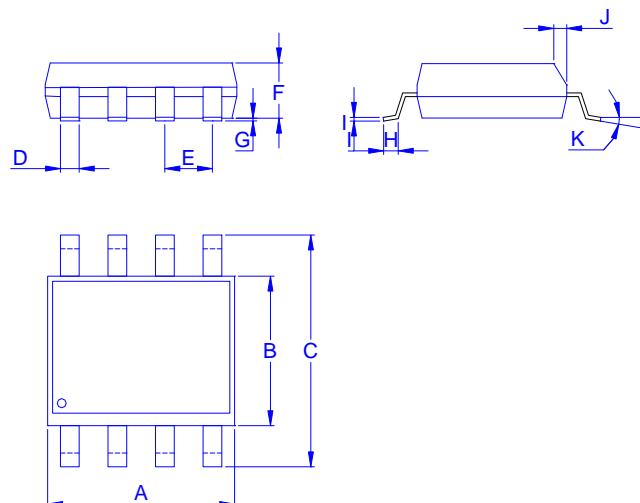
³Pulse width limited by maximum junction temperature.

Ordering & Marking Information:

Device Name: EMB21C03G for SOP-8



Outline Drawing

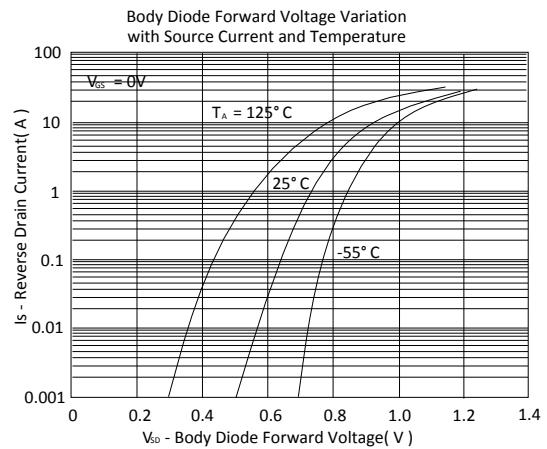
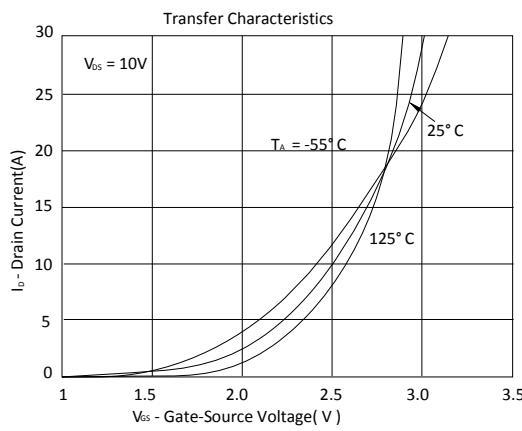
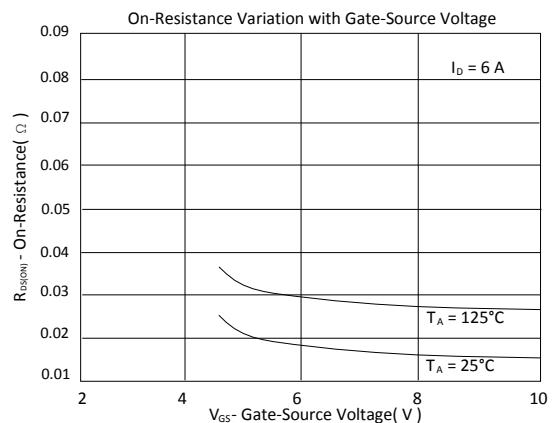
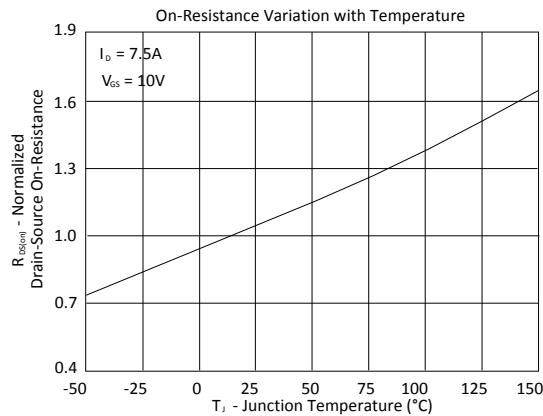
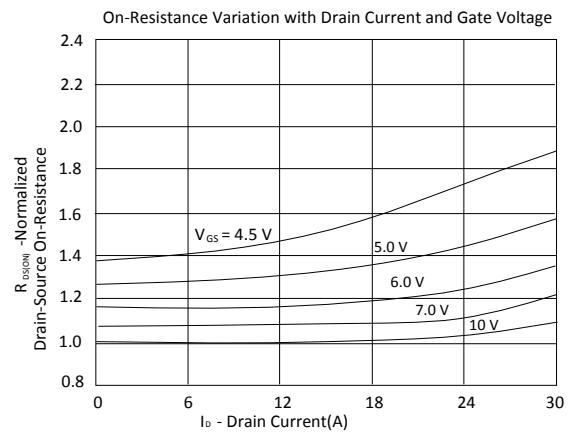
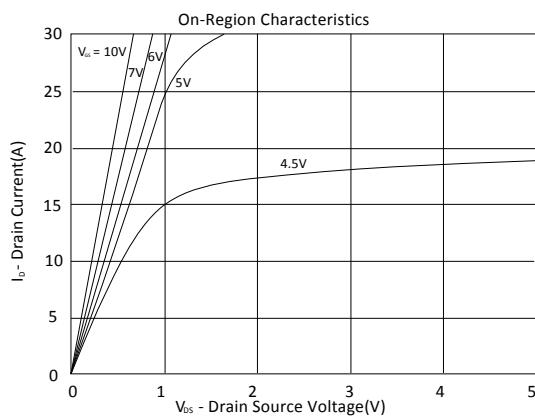


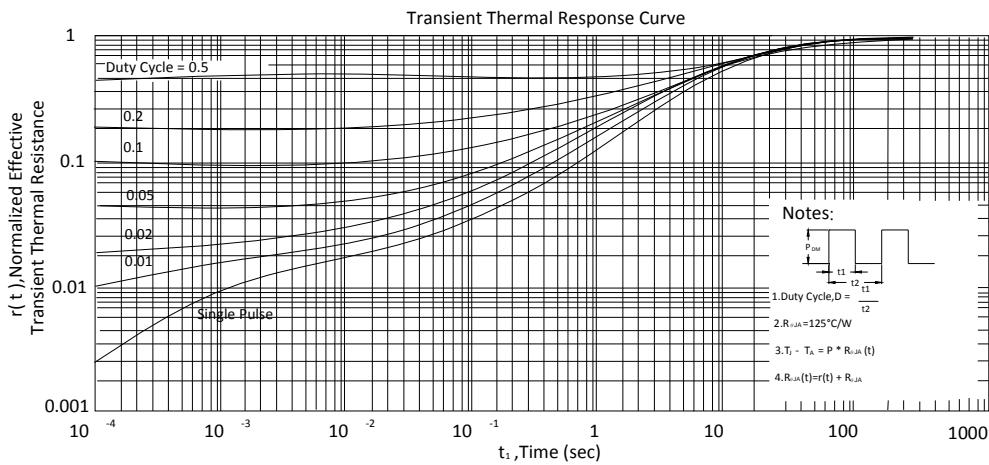
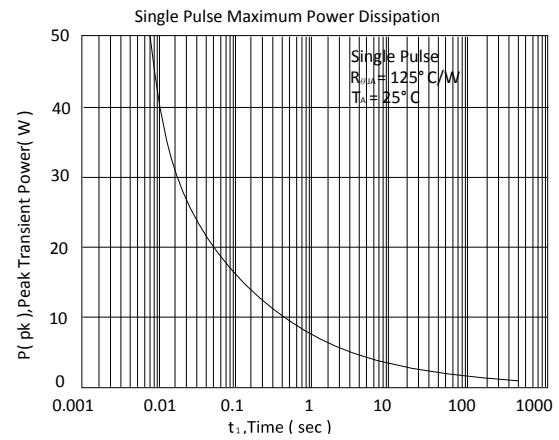
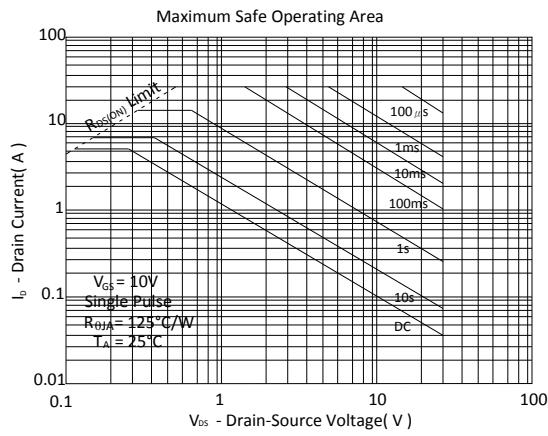
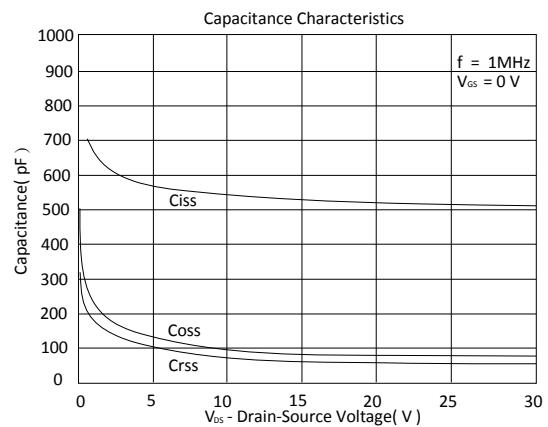
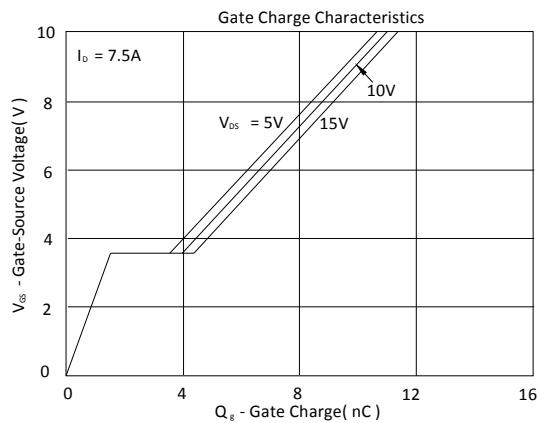
Dimension in mm

Dimension	A	B	C	D	E	F	G	H	I	J	K
Min.	4.70	3.70	5.80	0.33		1.20	0.08	0.40	0.19	0.25	0°
Typ.					1.27						
Max.	5.10	4.10	6.20	0.51		1.62	0.28	0.83	0.26	0.50	8°



N-Channel





P-Channel

